



IRF350-353
N-channel Power MOSFETs,
15 A, 350 V/400 V

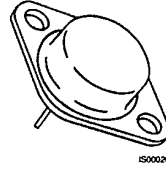
T-39-13

Power And Discrete Division

Description

These devices are n-channel, enhancement mode, power MOSFETs designed especially for high voltage, high speed applications, such as off-line switching power supplies, UPS, AC and DC motor controls, relay and solenoid drivers.

TO-204AA



- V_{GS} Rated at ± 20 V
- Silicon Gate for Fast Switching Speeds
- I_{DSS} , $V_{DS(on)}$, SOA and $V_{GS(th)}$ Specified at Elevated Temperature
- Rugged

IRF350
 IRF351
 IRF352
 IRF353

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Maximum Ratings

| Symbol | Characteristic | Rating IRF350/352 | Rating IRF351/353 | Unit |
|----------------|---|----------------------|----------------------|--------------------|
| V_{DSS} | Drain to Source Voltage | 400 | 350 | V |
| V_{DGR} | Drain to Gate Voltage $R_{GS} = 1.0 \text{ M}\Omega$ | 400 | 350 | V |
| V_{GS} | Gate to Source Voltage | ± 20 | ± 20 | V |
| T_J, T_{stg} | Operating Junction and Storage Temperatures | -55 to +150 | -55 to +150 | $^{\circ}\text{C}$ |
| T_L | Maximum Lead Temperature for Soldering Purposes, 1/8" From Case for 5 s | 275 | 275 | $^{\circ}\text{C}$ |

Maximum On-State Characteristics

| | | IRF350/351 | IRF352/353 | |
|--------------|--------------------------------------|------------|------------|----------|
| $R_{DS(on)}$ | Static Drain-to-Source On Resistance | 0.3 | 0.4 | Ω |
| I_D | Drain Current | | | A |
| | Continuous | 15 | 13 | |
| | Pulsed | 60 | 52 | |

Maximum Thermal Characteristics

| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | 0.83 | 0.83 | $^{\circ}\text{C}/\text{W}$ |
|-----------------|---|------|------|-----------------------------|
| P_D | Total Power Dissipation at $T_C = 25^{\circ}\text{C}$ | 150 | 150 | W |

Notes
 For information concerning connection diagram and package outline, refer to Section 7.

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Electrical Characteristics ($T_C = 25^\circ\text{C}$ unless otherwise noted)

| Symbol | Characteristic | Min | Max | Unit | Test Conditions |
|--|--|-----|-----------|----------------|--|
| Off Characteristics | | | | | |
| $V_{(BR)DSS}$ | Drain Source Breakdown Voltage ¹ | | | V | $V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$ |
| | IRF350/352 | 400 | | | |
| | IRF351/353 | 350 | | | |
| I_{DSS} | Zero Gate Voltage Drain Current | | 250 | μA | $V_{DS} = \text{Rated } V_{DSS}, V_{GS} = 0\text{ V}$ |
| | | | 1000 | μA | $V_{DS} = 0.8 \times \text{Rated } V_{DSS}, V_{GS} = 0\text{ V}, T_C = 125^\circ\text{C}$ |
| I_{GSS} | Gate-Body Leakage Current | | ± 100 | nA | $V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$ |
| On Characteristics | | | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | 2.0 | 4.0 | V | $I_D = 250\ \mu\text{A}, V_{DS} = V_{GS}$ |
| $R_{DS(on)}$ | Static Drain-Source On-Resistance ² | | | Ω | $V_{GS} = 10\text{ V}, I_D = 8.0\text{ A}$ |
| | IRF350/351 | | 0.3 | | |
| | IRF352/353 | | 0.4 | | |
| g_{fs} | Forward Transconductance | 8.0 | | S (Ω) | $V_{DS} = 10\text{ V}, I_D = 8.0\text{ A}$ |
| Dynamic Characteristics | | | | | |
| C_{iss} | Input Capacitance | | 3000 | pF | $V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V}$ $f = 1.0\text{ MHz}$ |
| C_{oss} | Output Capacitance | | 600 | pF | |
| C_{rss} | Reverse Transfer Capacitance | | 200 | pF | |
| Switching Characteristics ($T_C = 25^\circ\text{C}$, Figures 9, 10) | | | | | |
| $t_{d(on)}$ | Turn-On Delay Time | | 35 | ns | $V_{DD} = 180\text{ V}, I_D = 8.0\text{ A}$ $V_{GS} = 10\text{ V}, R_{GEN} = 4.7\ \Omega$ $R_{GS} = 4.7\ \Omega$ |
| t_r | Rise Time | | 65 | ns | |
| $t_{d(off)}$ | Turn-Off Delay Time | | 150 | ns | |
| t_f | Fall Time | | 75 | ns | |
| Q_g | Total Gate Charge | | 120 | nC | $V_{GS} = 10\text{ V}, I_D = 16\text{ A}$ $V_{DD} = 400\text{ V}$ |
| Symbol Characteristic Typ Max Unit Test Conditions | | | | | |
| Source-Drain Diode Characteristics | | | | | |
| V_{SD} | Diode Forward Voltage | | | V | $I_S = 15\text{ A}; V_{GS} = 0\text{ V}$ $I_S = 13\text{ A}; V_{GS} = 0\text{ V}$ |
| | IRF350/351 | | 1.6 | V | |
| | IRF352/353 | | 1.5 | V | |
| t_{rr} | Reverse Recovery Time | 600 | | ns | $I_S = 15\text{ A}; di_S/dt = 100\text{ A}/\mu\text{S}$ |

Notes

- $T_J = +25^\circ\text{C}$ to $+150^\circ\text{C}$
- Pulse test: Pulse width $\leq 80\ \mu\text{s}$, Duty cycle $\leq 1\%$

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Typical Performance Curves

Figure 1 Output Characteristics

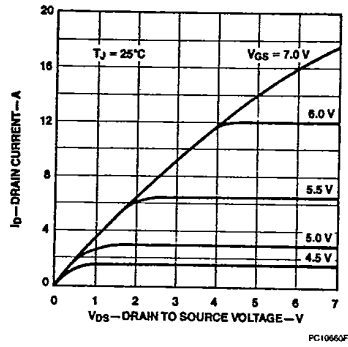


Figure 2 Static Drain to Source On Resistance vs Drain Current

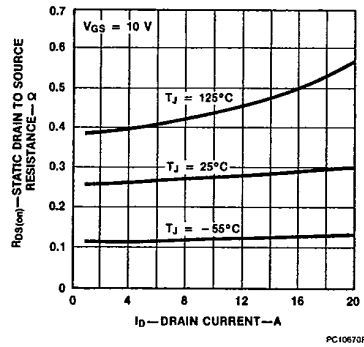


Figure 3 Transfer Characteristics

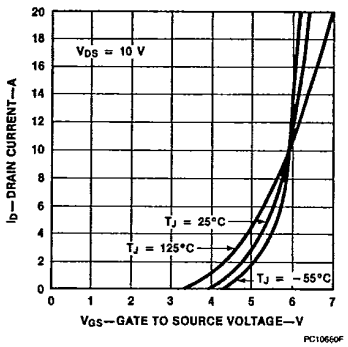


Figure 4 Temperature Variation of Gate to Source Threshold Voltage

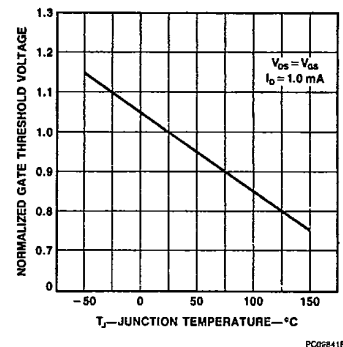


Figure 5 Capacitance vs Drain to Source Voltage

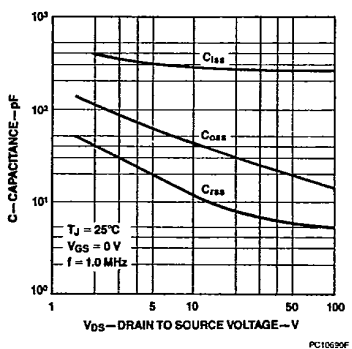
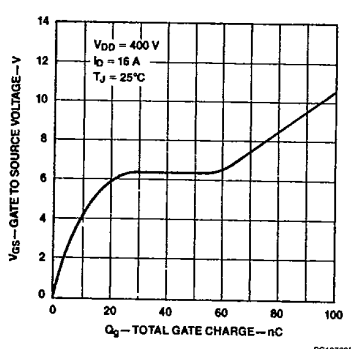


Figure 6 Gate to Source Voltage vs Total Gate Charge



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Typical Performance Curves (Cont.)

Figure 7 Forward Biased Safe Operating Area

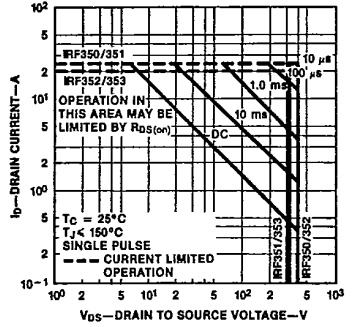
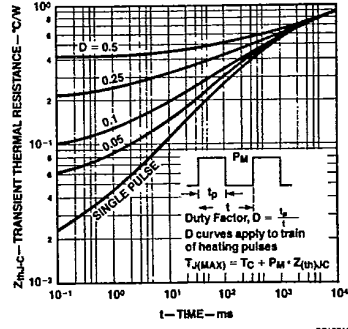


Figure 8 Transient Thermal Resistance vs Time



Typical Electrical Characteristics

Figure 9 Switching Test Circuit

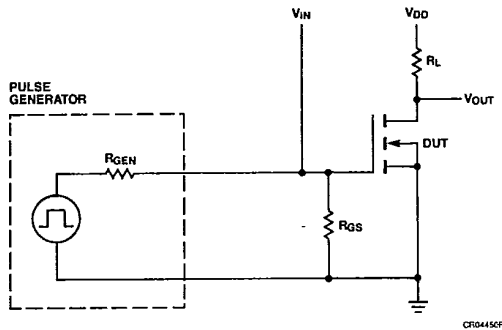


Figure 10 Switching Waveforms

